

Express Mail Label EV335521518US

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

IN RE APPLICATION OF: LINLIN CHEN *ET AL.*

FILED: OCTOBER 27, 2003

FOR: **APPARATUS AND METHOD FOR
ELECTROLYTICALLY DEPOSITING
COPPER ON A SEMICONDUCTOR
WORKPIECE**

Preliminary Amendment

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Commissioner:

Prior to examination on the merits, please amend the above-identified application as follows:

Amendments to the Specification begin on page 2.